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Fabrication Method:

Molded

Body Mounting Hole Accommodation Diameter:

0.330 inches

Mounting Hole Style:

Round, flatted

Specific Equipment Accommodated:

Semiconductor device

Contact Material:

Copper alloy

Contact Surface Treatment:

Silver

Accommodated Contact Quantity:

4

Polarization Type:

Center key hole

Distance From Flatted Portion To Opposite Surface:

0.280 inches

Mounting Type For Which Designed:

Chassis

Contact Position Arrangement Style:

Rectangular

Precious Material And Location:

Contact surfaces silver

Precious Material And Weight:

0.020 silver grains, troy

Precious Material:

Silver

Terminal Type And Quantity:

4 printed circuit

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

A02300